

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Mitsuru OKIGAWA

Serial No: 10/773,088

Filed: February 5, 2004

For: SEMICONDUCTOR INTEGRATED
DEVICE INCLUDING SUPPORT
SUBSTRATE FASTENED USING RESIN,
AND MANUFACTURING METHOD
THEREOF

STATUS REQUEST

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Art Unit: 2824

Examiner: Luhrs, M. K.

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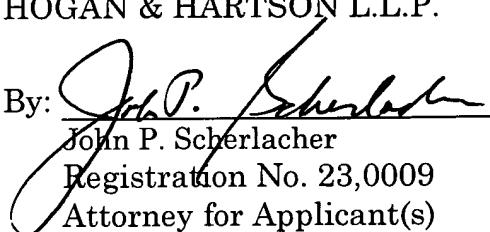
Dear Sir:

This application was filed on February 5, 2004 and receipt acknowledged by the Patent Office in that the postcard was returned with the application serial number 10/773,088. An official filing receipt was received from the Patent Office on August 12, 2004, and the Notice Of Recordation Of Assignment Document. No further papers have been received in this case.

Please send the undersigned a Status Report on this application.

Respectfully submitted,
HOGAN & HARTSON L.L.P.

By:


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Date: May 9, 2005

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